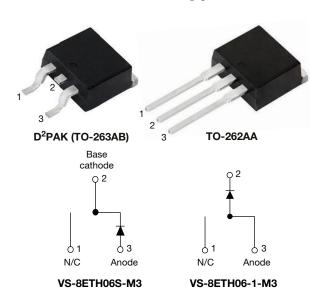


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# Hyperfast Rectifier, 8 A FRED Pt®



### **LINKS TO ADDITIONAL RESOURCES**



| PRIMARY CHARACTERISTICS          |   |  |  |  |  |  |  |
|----------------------------------|---|--|--|--|--|--|--|
| I <sub>F(AV)</sub>               | 8 A                                     |  |  |  |  |  |  |
| V <sub>R</sub>                   | 600 V                                   |  |  |  |  |  |  |
| V <sub>F</sub> at I <sub>F</sub> | 1.3 V                                   |  |  |  |  |  |  |
| t <sub>rr</sub> typ.             | 18 ns                                   |  |  |  |  |  |  |
| T <sub>J</sub> max.              | 175 °C                                  |  |  |  |  |  |  |
| Package                          | D <sup>2</sup> PAK (TO-263AB), TO-262AA |  |  |  |  |  |  |
| Circuit configuration            | Common cathode                          |  |  |  |  |  |  |

#### **FEATURES**

- · Hyperfast recovery time
- Low forward voltage drop
- Low leakage current
- 175 °C operating junction temperature



- Meets MSL level 1, per J-STD-020, LF maximum peak of 245 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **DESCRIPTION / APPLICATIONS**

State of the art hyperfast recovery rectifiers designed with optimized performance of forward voltage drop, hyperfast recovery time, and soft recovery.

The planar structure and the platinum doped life time control guarantee the best overall performance, ruggedness and reliability characteristics.

These devices are intended for use in PFC boost stage in the AC/DC section of SMPS, inverters or as freewheeling diodes.

Their extremely optimized stored charge and low recovery current minimize the switching losses and reduce over dissipation in the switching element and snubbers.

### **MECHANICAL DATA**

Case: D<sup>2</sup>PAK (TO-263AB), TO-262AA

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per

J-STD-002

| ABSOLUTE MAXIMUM RATINGS                    |                    |                         |             |       |  |  |  |  |
|---|--------------------|-------------------------|-------------|-------|--|--|--|--|
| PARAMETER                                   | SYMBOL             | TEST CONDITIONS         | MAX.        | UNITS |  |  |  |  |
| Peak repetitive reverse voltage             | $V_{RRM}$          |                         | 600         | V     |  |  |  |  |
| Average rectified forward current           | I <sub>F(AV)</sub> | T <sub>C</sub> = 144 °C | 8           |       |  |  |  |  |
| Non-repetitive peak surge current           | I <sub>FSM</sub>   | T <sub>J</sub> = 25 °C  | 90          | Α     |  |  |  |  |
| Peak repetitive forward current             | I <sub>FM</sub>    |                         | 16          |       |  |  |  |  |
| Operating junction and storage temperatures | $T_J$ , $T_{Stg}$  |                         | -65 to +175 | °C    |  |  |  |  |

| <b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified) |                                 |   |     |      |      |       |  |  |
|--|---------------------------------|---|-----|------|------|-------|--|--|
| PARAMETER  | ARAMETER SYMBOL TEST CONDITIONS |   |     | TYP. | MAX. | UNITS |  |  |
| Breakdown voltage,<br>blocking voltage   | $V_{BR}$ , $V_{R}$              | Ι <sub>R</sub> = 100 μΑ                                 | 600 | -    | -    | .,    |  |  |
| Forward voltage  | V <sub>F</sub>                  | I <sub>F</sub> = 8 A                                    | -   | 2.0  | 2.4  | V     |  |  |
|  |                                 | I <sub>F</sub> = 8 A, T <sub>J</sub> = 150 °C           | -   | 1.3  | 1.8  |       |  |  |
| Povorce leekage ourrent  | I <sub>R</sub>                  | $V_R = V_R$ rated                                       | -   | 0.03 | 50   |       |  |  |
| Reverse leakage current  |                                 | $T_J = 150  ^{\circ}\text{C},  V_R = V_R  \text{rated}$ | -   | 55   | 500  | μΑ    |  |  |
| Junction capacitance   | C <sub>T</sub>                  | V <sub>R</sub> = 600 V                                  | -   | 17   | -    | pF    |  |  |
| Series inductance  | L <sub>S</sub>                  | Measured lead to lead 5 mm from package body            | -   | 8.0  | -    | nΗ    |  |  |



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| <b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>C</sub> = 25 °C unless otherwise specified) |                  |                             |  |   |     |      |       |
|---|------------------|-----------------------------|--|---|-----|------|-------|
| PARAMETER   | SYMBOL           | TEST CO                     | TEST CONDITIONS  |   |     | MAX. | UNITS |
| Reverse recovery time   |                  | $I_F = 1 A$ , $dI_F/dt = 1$ | 00 A/μs, V <sub>R</sub> = 30 V   | - | 18  | 22   |       |
|   |                  | $I_F = 8 A, dI_F/dt = 1$    | 00 A/μs, V <sub>R</sub> = 30 V   | - | 20  | 25   | no    |
|   | t <sub>rr</sub>  | T <sub>J</sub> = 25 °C      |  | - | 25  | -    | ns    |
|   |                  | T <sub>J</sub> = 125 °C     | I <sub>F</sub> = 8 A<br>dI <sub>F</sub> /dt = 200 A/μs<br>V <sub>B</sub> = 390 V | - | 40  | -    |       |
| Dools was assembled to survey the   |                  | T <sub>J</sub> = 25 °C      |  | - | 2.4 | -    | А     |
| Peak recovery current   | IRRM             | T <sub>J</sub> = 125 °C     |  | - | 4.8 | -    |       |
| Daverse receiver charge   | 0                | T <sub>J</sub> = 25 °C      | ] "  | - | 25  | -    |       |
| Reverse recovery charge   | Q <sub>rr</sub>  | T <sub>J</sub> = 125 °C     | 1  | - | 120 | -    | nC    |
| Reverse recovery time   | t <sub>rr</sub>  |                             | I <sub>E</sub> = 8 A   | - | 33  | -    | ns    |
| Peak recovery current   | I <sub>RRM</sub> | T <sub>J</sub> = 125 °C     | $dI_F/dt = 600 A/\mu s$  | - | 12  | -    | Α     |
| Reverse recovery charge   | Q <sub>rr</sub>  |                             | $V_{R} = 390 \text{ V}$  | - | 220 | -    | nC    |

| THERMAL - MECHANICAL SPECIFICATIONS             |                                   |   |           |          |            |                        |  |  |
|---|-----------------------------------|---|-----------|----------|------------|------------------------|--|--|
| PARAMETER                                       | SYMBOL                            | TEST CONDITIONS                             | MIN.      | TYP.     | MAX.       | UNITS                  |  |  |
| Maximum junction and storage temperature range  | T <sub>J</sub> , T <sub>Stg</sub> |   | -65       | -        | 175        | °C                     |  |  |
| Thermal resistance, junction to case per leg    | R <sub>thJC</sub>                 |   | -         | 1.4      | 2          |                        |  |  |
| Thermal resistance, junction to ambient per leg | R <sub>thJA</sub>                 | Typical socket mount                        | -         | -        | 70         | °C/W                   |  |  |
| Thermal resistance, case to heatsink            | R <sub>thCS</sub>                 | Mounting surface, flat, smooth, and greased | -         | 0.5      | -          |                        |  |  |
| Maight  |                                   |   | -         | 2.0      | -          | g                      |  |  |
| Weight  |                                   |   | -         | 0.07     | -          | oz.                    |  |  |
| Mounting torque                                 |                                   |   | 6.0 (5.0) | -        | 12<br>(10) | kgf · cm<br>(lbf · in) |  |  |
|   |                                   | Case style D <sup>2</sup> PAK (TO-263AB)    |           | 8ETH06S  |            |                        |  |  |
| Marking device                                  |                                   | Case style TO-262AA                         |           | 8ETH06-1 |            |                        |  |  |

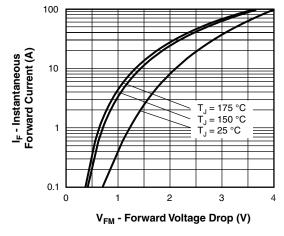


Fig. 1 - Maximum Forward Voltage Drop Characteristics

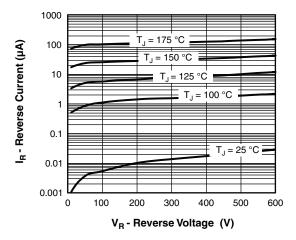


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

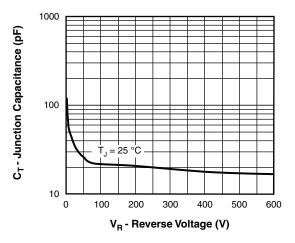


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

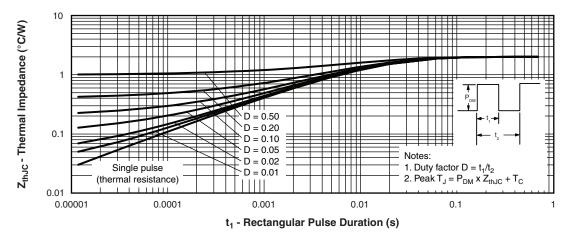


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

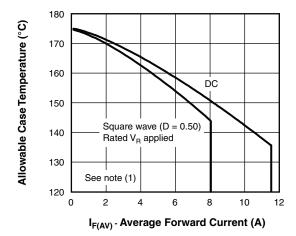


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

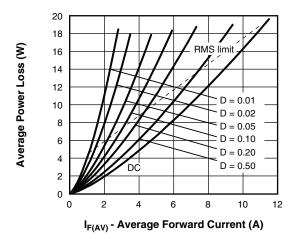


Fig. 6 - Forward Power Loss Characteristics

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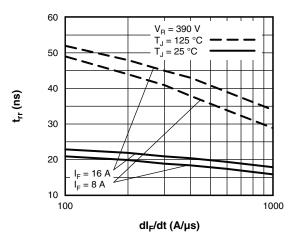


Fig. 7 - Typical Reverse Recovery Time vs. dl<sub>F</sub>/dt

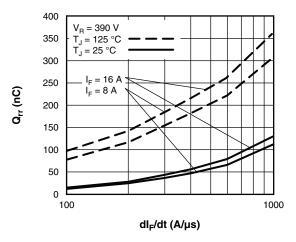
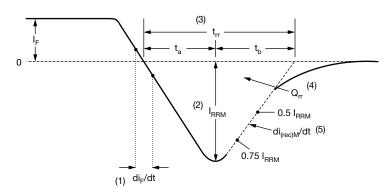


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

#### Note

 $^{(1)}$  Formula used: T<sub>C</sub> = T<sub>J</sub> - (Pd + Pd<sub>REV</sub>) x R<sub>thJC</sub>; Pd = forward power loss = I<sub>F(AV)</sub> x V<sub>FM</sub> at (I<sub>F(AV)</sub>/D) (see fig. 6); Pd<sub>REV</sub> = inverse power loss = V<sub>R1</sub> x I<sub>R</sub> (1 - D); I<sub>R</sub> at V<sub>R1</sub> = rated V<sub>R</sub>



- (1) di<sub>F</sub>/dt rate of change of current through zero crossing
- (2) I<sub>RRM</sub> peak reverse recovery current
- (3) t<sub>rr</sub> reverse recovery time measured from zero crossing point of negative going I<sub>F</sub> to point where a line passing through 0.75 I<sub>RBM</sub> and 0.50 I<sub>RBM</sub> extrapolated to zero current.
- (4)  $\mathbf{Q}_{\rm rr}$  area under curve defined by  $\mathbf{t}_{\rm rr}$  and  $\mathbf{I}_{\rm RRM}$

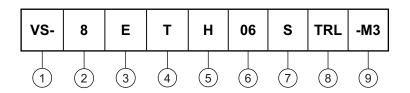
$$Q_{rr} = \frac{t_{rr} \times I_{RRM}}{2}$$

(5) di<sub>(rec)M</sub>/dt - peak rate of change of current during t<sub>b</sub> portion of t<sub>rr</sub>

Fig. 9 - Reverse Recovery Waveform and Definitions

### **ORDERING INFORMATION TABLE**

Device code



1 - Vishay Semiconductors product

2 - Current rating (8 A)

E = single diode

-  $T = TO-220, D^2PAK (TO-263AB)$ 

5 - H = hyperfast rectifier

6 - Voltage rating (06 = 600 V)

7 - • S =  $D^2PAK$  (TO-263AB)

• -1 = TO-262AA

None = tube (50 pieces)

• TRL = tape and reel (left oriented, for D<sup>2</sup>PAK (TO-263AB) package)

• TRR = tape and reel (right oriented, for D<sup>2</sup>PAK (TO-263AB) package)

9 - Environmental digit:

-M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) |               |                                    |  |  |  |  |  |
|--------------------------------|---------------|------------------------------------|--|--|--|--|--|
| PREFERRED P/N                  | BASE QUANTITY | PACKAGING DESCRIPTION              |  |  |  |  |  |
| VS-8ETH06S-M3                  | 50            | Antistatic plastic tubes           |  |  |  |  |  |
| VS-8ETH06STRL-M3               | 800           | 13" diameter plastic tape and reel |  |  |  |  |  |
| VS-8ETH06STRR-M3               | 800           | 13" diameter plastic tape and reel |  |  |  |  |  |
| VS-8ETH06-1-M3                 | 50            | Antistatic plastic tubes           |  |  |  |  |  |

| LINKS TO RELATED DOCUMENTS |                               |                          |  |  |  |  |
|----------------------------|-------------------------------|--------------------------|--|--|--|--|
| Dimensions —               | D <sup>2</sup> PAK (TO-263AB) | www.vishay.com/doc?96164 |  |  |  |  |
| Dimensions                 | TO-262AA                      | www.vishay.com/doc?96165 |  |  |  |  |
| Dort marking information   | D <sup>2</sup> PAK (TO-263AB) | www.vishay.com/doc?95444 |  |  |  |  |
| Part marking information — | TO-262AA                      | www.vishay.com/doc?95443 |  |  |  |  |
| Packaging information      | D <sup>2</sup> PAK (TO-263AB) | www.vishay.com/doc?96424 |  |  |  |  |



# D<sup>2</sup>PAK

### **DIMENSIONS** in millimeters and inches



| SYMBOL  | MILLIM | ETERS | INC   | HES   | NOTES |       | SYMBOL | MILLIM | ETERS | INC   | HES   | NOTES |
|---------|--------|-------|-------|-------|-------|-------|--------|--------|-------|-------|-------|-------|
| STWIBOL | MIN.   | MAX.  | MIN.  | MAX.  | NOTES | NOTES | STWBOL | MIN.   | MAX.  | MIN.  | MAX.  | NOTES |
| Α       | 4.06   | 4.83  | 0.160 | 0.190 |       |       | D1     | 6.86   | 8.00  | 0.270 | 0.315 | 3     |
| A1      | 0.00   | 0.254 | 0.000 | 0.010 |       |       | Е      | 9.65   | 10.67 | 0.380 | 0.420 | 2, 3  |
| b       | 0.51   | 0.99  | 0.020 | 0.039 |       |       | E1     | 7.90   | 8.80  | 0.311 | 0.346 | 3     |
| b1      | 0.51   | 0.89  | 0.020 | 0.035 | 4     |       | е      | 2.54   | BSC   | 0.100 | BSC   |       |
| b2      | 1.14   | 1.78  | 0.045 | 0.070 |       |       | Н      | 14.61  | 15.88 | 0.575 | 0.625 |       |
| b3      | 1.14   | 1.73  | 0.045 | 0.068 | 4     |       | L      | 1.78   | 2.79  | 0.070 | 0.110 |       |
| С       | 0.38   | 0.74  | 0.015 | 0.029 |       |       | L1     | -      | 1.65  | -     | 0.066 | 3     |
| c1      | 0.38   | 0.58  | 0.015 | 0.023 | 4     |       | L2     | 1.27   | 1.78  | 0.050 | 0.070 |       |
| c2      | 1.14   | 1.65  | 0.045 | 0.065 |       |       | L3     | 0.25   | BSC   | 0.010 | BSC   |       |
| D       | 8.51   | 9.65  | 0.335 | 0.380 | 2     |       | L4     | 4.78   | 5.28  | 0.188 | 0.208 |       |

#### Notes

- (1) Dimensioning and tolerancing per ASME Y14.5 M-1994
- (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- (3) Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- (5) Datum A and B to be determined at datum plane H
- (6) Controlling dimension: inches
- (7) Outline conforms to JEDEC® outline TO-263AB

Revision: 13-Jul-17 Document Number: 96164



## **TO-262AA**

### **DIMENSIONS** in millimeters and inches

#### Modified JEDEC® outline TO-262







**⊕** 0.010 **M** A**M** B

#### Lead assignments



**Diodes** 1. - Anode (two die)/open (one die)

2., 4. - Cathode

3. - Anode



Section B - B and C - C Scale: None

| SYMBOL  | MILLIM | IETERS | INC   | INCHES |       |  |  |  |
|---------|--------|--------|-------|--------|-------|--|--|--|
| STWIBOL | MIN.   | MAX.   | MIN.  | MAX.   | NOTES |  |  |  |
| Α       | 4.06   | 4.83   | 0.160 | 0.190  |       |  |  |  |
| A1      | 2.03   | 3.02   | 0.080 | 0.119  |       |  |  |  |
| b       | 0.51   | 0.99   | 0.020 | 0.039  |       |  |  |  |
| b1      | 0.51   | 0.89   | 0.020 | 0.035  | 4     |  |  |  |
| b2      | 1.14   | 1.78   | 0.045 | 0.070  |       |  |  |  |
| b3      | 1.14   | 1.73   | 0.045 | 0.068  | 4     |  |  |  |
| С       | 0.38   | 0.74   | 0.015 | 0.029  |       |  |  |  |
| c1      | 0.38   | 0.58   | 0.015 | 0.023  | 4     |  |  |  |
| c2      | 1.14   | 1.65   | 0.045 | 0.065  |       |  |  |  |
| D       | 8.51   | 9.65   | 0.335 | 0.380  | 2     |  |  |  |
| D1      | 6.86   | 8.00   | 0.270 | 0.315  | 3     |  |  |  |
| E       | 9.65   | 10.67  | 0.380 | 0.420  | 2, 3  |  |  |  |
| E1      | 7.90   | 8.80   | 0.311 | 0.346  | 3     |  |  |  |
| е       | 2.54   | BSC    | 0.100 | ) BSC  |       |  |  |  |
| L       | 13.46  | 14.10  | 0.530 | 0.555  |       |  |  |  |
| L1      | -      | 1.65   | -     | 0.065  | 3     |  |  |  |
| L2      | 3.56   | 3.71   | 0.140 | 0.146  |       |  |  |  |

### **Notes**

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
  (2) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outmost extremes of the plastic body
- Thermal pad contour optional within dimension E, L1, D1 and E1
- (4) Dimension b1 and c1 apply to base metal only
- Controlling dimension: inches
- Outline conform to JEDEC® TO-262 except A1 (max.), b (min., max.), b1 (min.), b2 (max.), c (min.), c1(min.), c2 (max.), D (min.), E (max.), L1 (max.), L2 (min., max.)



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